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December 2014

FCP260N60E / FCPF260N60E N-Channel SuperFET[®] II Easy-Drive MOSFET

600 V, 15 A, 260 m Ω

Features

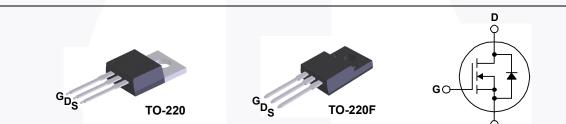
- 650 V @ T_J = 150°C
- Typ. R_{DS(on)} = 220 mΩ
- Ultra Low Gate Charge (Typ. Q_q = 48 nC)
- Low Effective Output Capacitance (Typ. Coss(eff.) = 129 pF)
- 100% Avalanche Tested
- An Integrated Gate Resistor
- RoHS Compliant

Applications

- LCD / LED / PDP TV Lighting
- Solar Inverter
- AC-DC Power Supply

Description

SuperFET[®] II MOSFET is Fairchild Semiconductor's brand-new high voltage super-junction (SJ) MOSFET family that is utilizing charge balance technology for outstanding low on-resistance and lower gate charge performance. This technology is tailored to minimize conduction loss, provide superior switching performance, dv/dt rate and higher avalanche energy. Consequently, SuperFET II MOSFET easy-drive series offers slightly slower rise and fall times compared to the SuperFET II MOSFET series. Noted by the "E" part number suffix, this family helps manage EMI issues and allows for easier design implementation. For faster switching in applications where switching losses must be at an absolute minimum, please consider the Super-FET II MOSFET series.



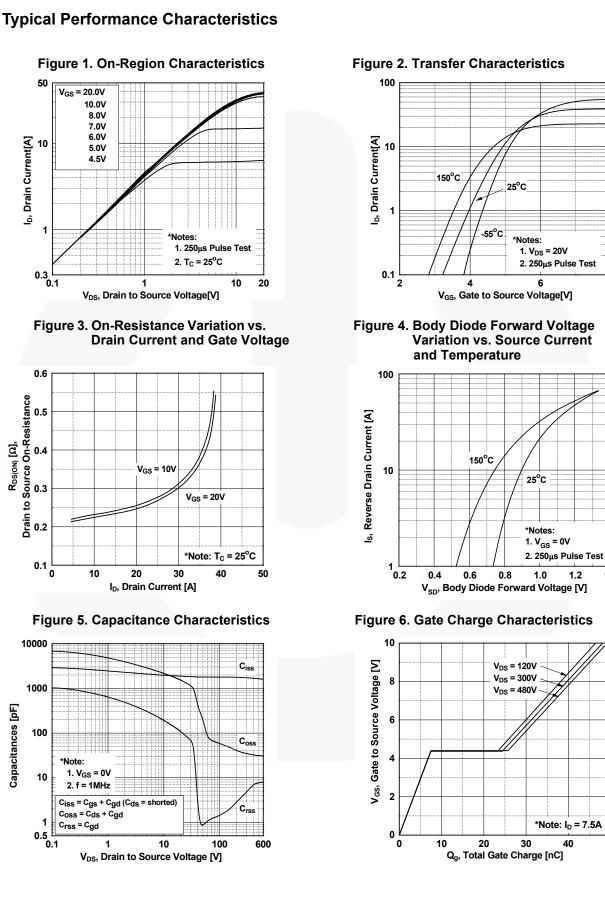
MOSFET Maximum Ratings T_C = 25°C unless otherwise noted.

Symbol		FCP260N60E	FCPF260N60E	Unit		
V _{DSS}	Drain to Source Voltage		6	V		
V _{GSS}	Cata ta Sauraa Valtaga	- DC	- DC		20	V
	Gate to Source Voltage	- AC	(f > 1 Hz)	±30		V
I _D	Drain Current	- Continuous (T _C = 25°C)		15	15*	Α
		- Continuous (T _C = 100 ^o C)		9.5	9.5*	A
I _{DM}	Drain Current	- Pulsed	45	45*	Α	
E _{AS}	Single Pulsed Avalanche Er	29	mJ			
I _{AR}	Avalanche Current	(Note 1)	3.0		Α	
E _{AR}	Repetitive Avalanche Energy			1.56		mJ
dv/dt	MOSFET dv/dt	1	V/ns			
	Peak Diode Recovery dv/dt (Note			20		
P _D	Dower Discipation	(T _C = 25 ^o C)		156	36	W
	Power Dissipation	- Derate Above 25°C		1.25	0.29	W/ºC
T _J , T _{STG}	Operating and Storage Tem	-55 te	°C			
ΤL	Maximum Lead Temperatur	3	°C			
Drain current	limited by maximum junction temp	perature	1			

Thermal Characteristics

Symbol	Parameter	FCP260N60E	FCPF260N60E	Unit
$R_{ ext{ heta}JC}$	Thermal Resistance, Junction to Case, Max.	0.8	3.5	°C/W
$R_{ hetaJA}$	Thermal Resistance, Junction to Ambient, Max.	62.5	62.5	°C/W

Part Number Top Mark P		Packag	ckage Packing Method Reel Siz		e	Tape Widt	h Qι	uantity			
		TO-22	0	Tube	N/A		N/A	50) units		
FCPF260N60E FCPF260N60E TC			TO-220	220F Tube N/A			N/A		50	50 units	
Electrica	I Char		C unless	otherwi	se noted.						
Symbol	nbol Parameter			Test Conditions			Min.	Тур.	Max.	Unit	
Off Charac	teristic	S									
BV _{DSS}	Drain to	Source Breakdown Voltage		$V_{GS} = 0 V, I_D = 10 mA, T_J = 25^{\circ}C$ $V_{GS} = 0 V, I_D = 10 mA, T_J = 150^{\circ}C$			600 650	-	-	v	
ΔΒV _{DSS} /ΔT _J		Breakdown Voltage Temperature Coefficient			$I_D = 10$ mA, Referenced to $25^{\circ}C$			0.67	-	V/ºC	
BV _{DS}	Drain to Voltage	Drain to Source Avalanche Breakdown			V _{GS} = 0 V, I _D = 15 A			700	-	V	
I _{DSS}	Zero Gate Voltage Drain Current			V _{DS} = 600 V, V _{GS} = 0 V			-	-	1	μA	
		,		50	$V, T_{C} = 125^{\circ}C$		-	2.6	-		
I _{GSS}	Gate to Body Leakage Current			/ _{GS} = ±2	0 V, V _{DS} = 0 V		-	-	±100	nA	
On Charac	teristic	S									
V _{GS(th)}	Gate Threshold Voltage			$V_{GS} = V_{DS}, I_{D} = 250 \ \mu A$			2.5	-	3.5	V	
R _{DS(on)}	Static Drain to Source On Resistance			V _{GS} = 10 V, I _D = 7.5 A			-	0.22	0.26	Ω	
9 _{FS}	Forward Transconductance			V _{DS} = 20 V, I _D = 7.5 A			-	15.5	-	S	
Dynamic C	haracte	eristics									
C _{iss}	-	apacitance					-	1880	2500	pF	
C _{oss}		out Capacitance erse Transfer Capacitance		$V_{\rm DS} = 25 \text{ V}, \text{ V}_{\rm GS} = 0 \text{ V},$		-	1330	1770	pF		
C _{rss}				f = 1 MHz			-	85	130	pF	
C _{oss}		Dutput Capacitance			V _{DS} = 380 V, V _{GS} = 0 V, f = 1 MHz			32	-	pF	
C _{oss(eff.)}		fective Output Capacitance		$V_{DS} = 0 V \text{ to } 480 V, V_{GS} = 0 V$			-	129	-	pF	
Q _{g(tot)}		Gate Charge at 10V		$V_{DS} = 380 \text{ V}, \text{ I}_{D} = 7.5 \text{ A},$ $V_{GS} = 10 \text{ V}$			-	48	62	nC	
Q _{gs}		o Source Gate Charge					-	7.4	-	nC	
Q _{gd}		to Drain "Miller" Charge		(Note 4)			-	17	-	nC	
ESR	-	ivalent Series Resistance		f = 1 MHz			-	5.8	-	Ω	
Switching	Charac	toristics				I					
t _{d(on)}	Turn-On Delay Time						1.	20	50	ns	
t _r		Turn-On Rise Time Turn-Off Delay Time		V _{DD} = 380 V, I _D = 7.5 A,			-	11	32	ns	
t _{d(off)}				$V_{GS} = 10 \text{ V}, \text{ R}_{G} = 4.7 \Omega$ (Note 4)		-	89	188	ns		
t _f Turn-Off Fall						-	13	36	ns		
						(1			
	1	le Characteristics			rd Curront				15	۸	
I _S	Maximum Continuous Drain to Source D Maximum Pulsed Drain to Source Diode						-	-	15 45	A	
I _{SM}	Drain to Source Diode Forward Voltage						-	-	45	A V	
V _{SD}				00 05			-	- 270	1.2		
$\frac{t_{rr}}{0}$	Reverse Recovery Time Reverse Recovery Charge			V _{GS} = 0 V, I _{SD} = 7.5 A, dI _F /dt = 100 A/μs					-	ns	
Q _{rr}	NEVEISE	Tecovery Charge	U		00 Αγμο		-	3.6	-	μC	
2. I _{AS} = 3 A, V _{DD} =	50 V, R _G = 2	limited by maximum junction tempe 5 Ω , starting T _J = 25°C. V _{DD} ≤ BV _{DSS} , starting T _J = 25°C.	erature.								

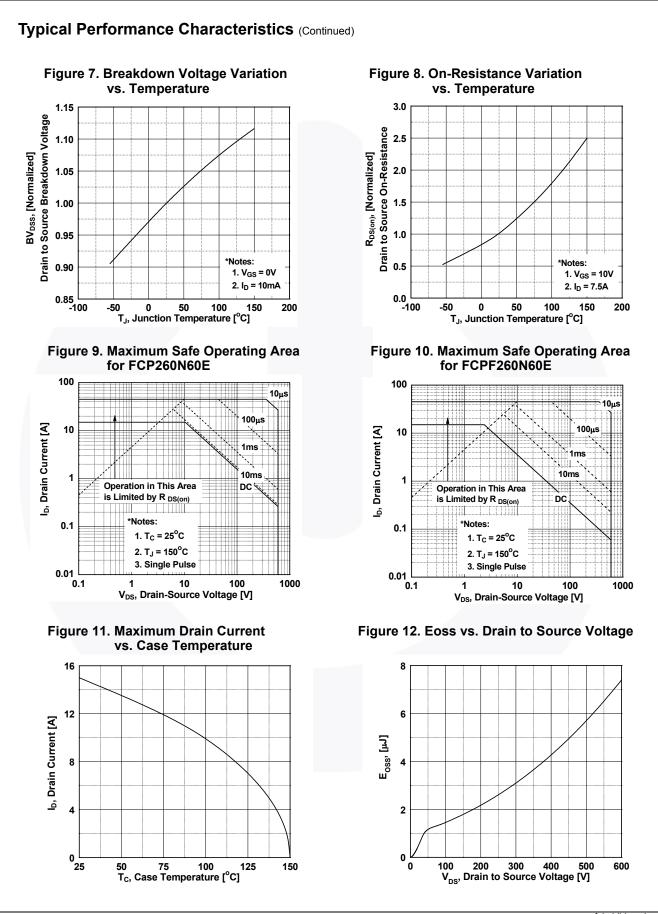


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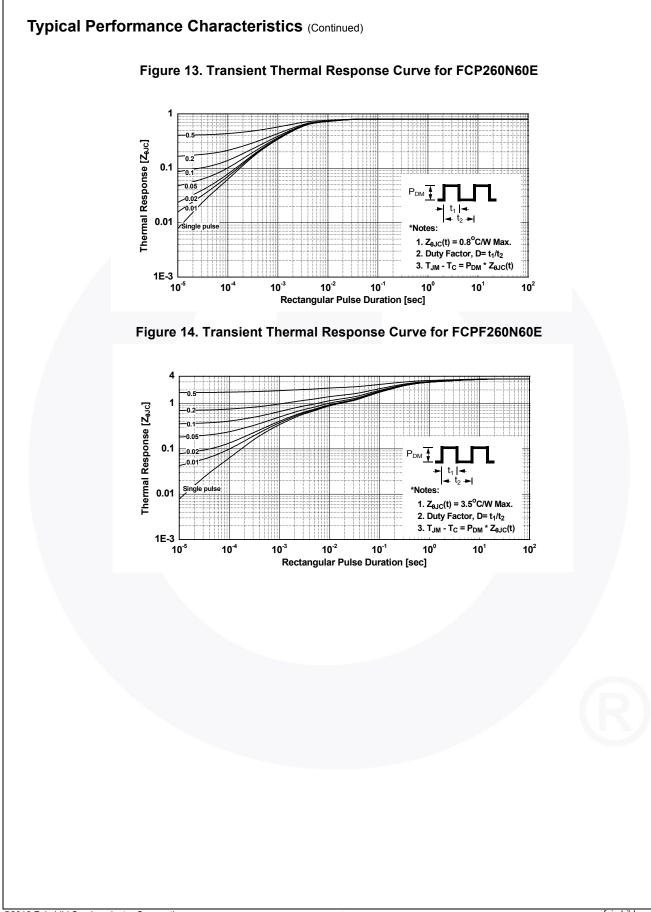
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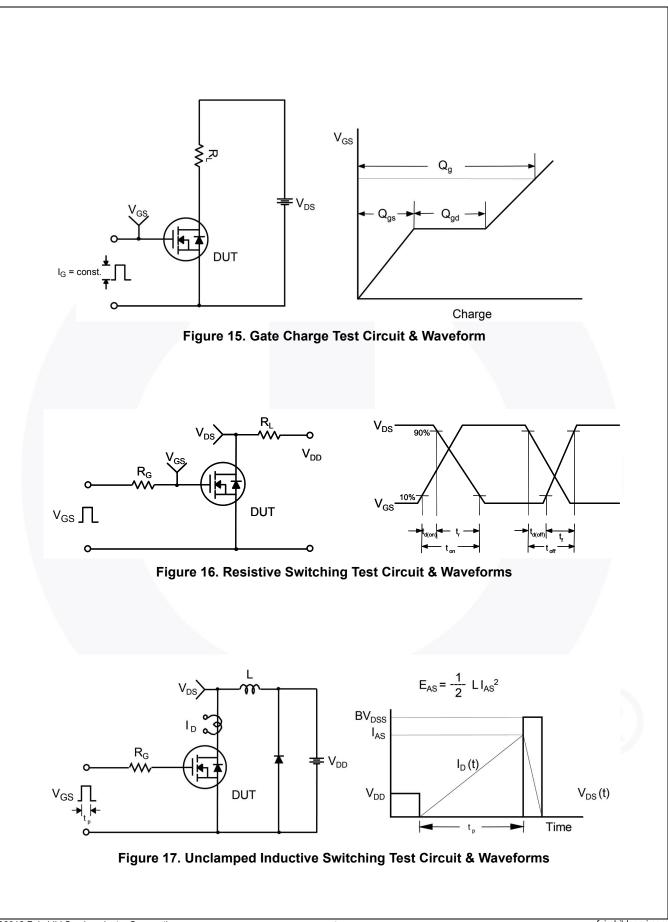


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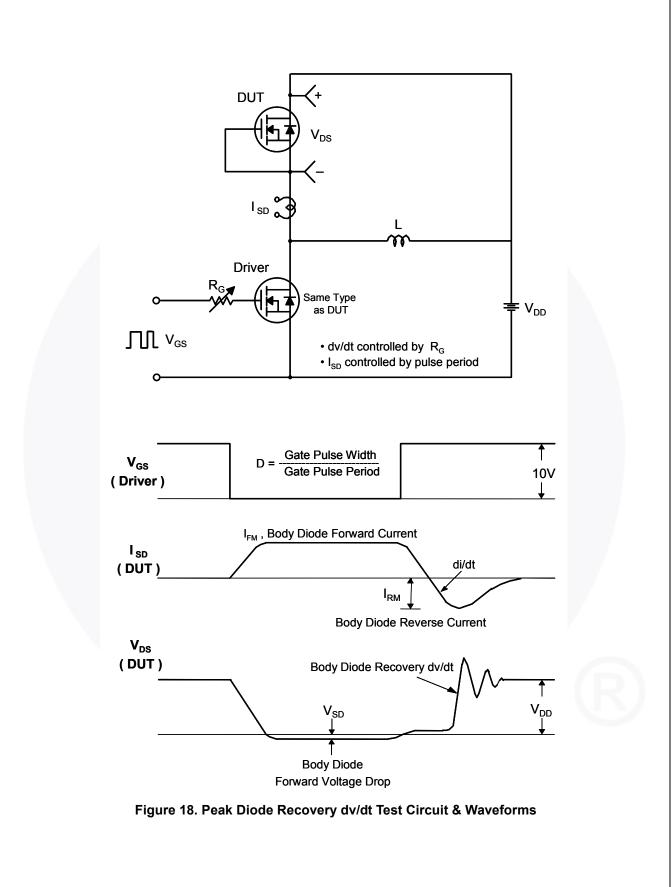


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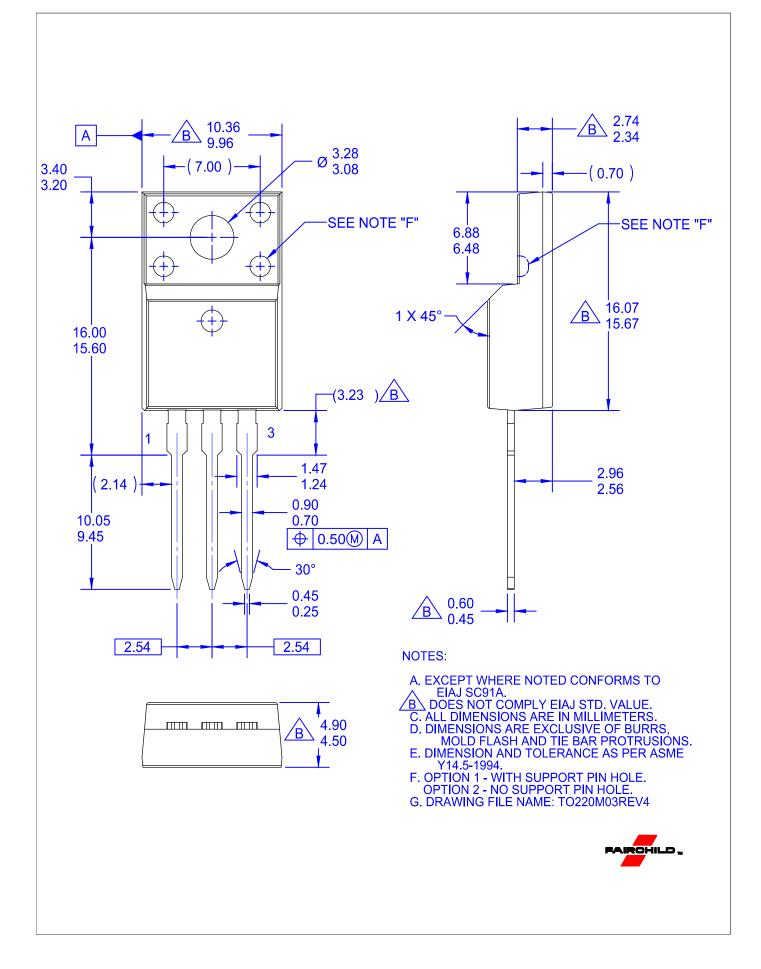


FCP260N60E / FCPF260N60E — N-Channel SuperFET[®] II Easy-Drive MOSFET

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